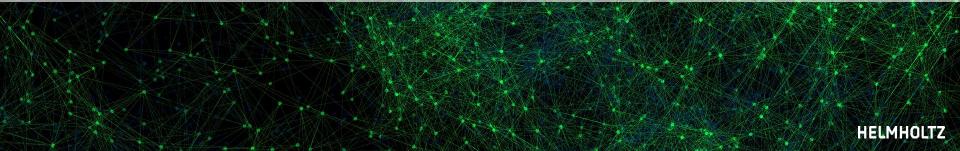
Program MSE MSE Day 18.11.2022

Knowledge Transfer & Innovation – Different Ways from Lab to Fab

Michael Hirtz, Nathalie Matter-König, Jasmin Aghassi-Hagmann



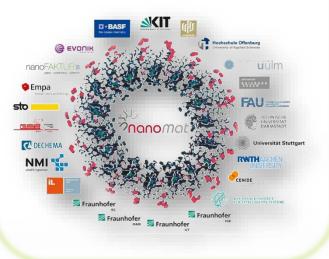
Knowledge Transfer & Innovation – Different Ways from Lab to Fab Three exemplary Stories



II. Innovation – from Paper to Product



III. Knowledge Transfer& Networking –NanoMat / MaTeLiS



HELMHOLTZ

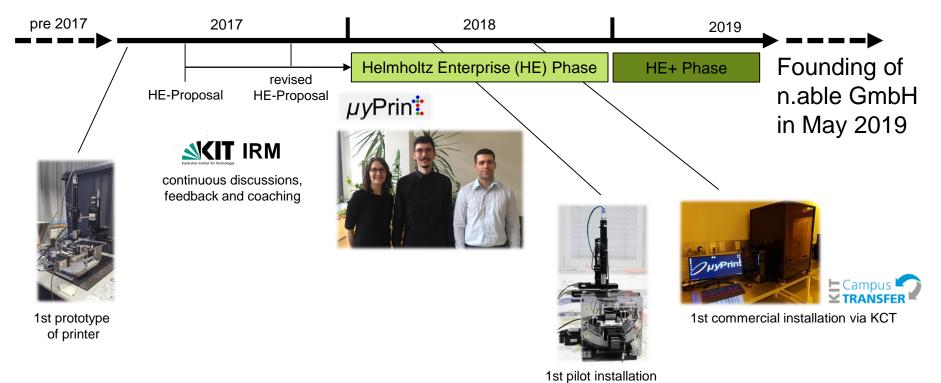
Founding a Spin-Off



Founding a Spin-Off at KIT The Idea is there – now what?



Founding a Spin-Off at KIT A long Story short



Founding a Spin-Off at KIT n.able GmbH



Innovation with Industry



Knowledge Transfer to Industry SensIC

Sensie BMBF-funded Research Project

"Eindeutige Identifizierbarkeit für vertrauenswürdige Hybrid-Sensorelektronik mit Hilfe additiver Fertigung" (SensIC)

- **Mission**: Establish product authenticity and security for new hybrid electronic systems, exemplified by a temperature monitoring system in hose systems for automotive/industry
- Total Budget 4,25 Mio.€, KIT Budget 700k€, runtime 2021–2024 Research topics: Printed temperature sensors, hardware-based security, development of hybrid systems (combination of silicon based and printed electronic)

Project Partners

- Continental AG (Projektkoordination)
- Cyient GmbH <</p>
- Hochschule Offenburg Mchschule Offenburg
- Karlsruher Institute of Technology
- Leibnitz INM INM
- Polysecure GmbH POLYSECURE



Knowledge Transfer to Industry SensIC

New value chain - "hybrid

Sensie BMBF-funded Research Project

Smart Pipe Systems

- printed front-end for temperature sensor (Continental, Leibniz INM), and silicon based IC in foundrytechnology, 180nm TSMC (Cyient)
- printed "physical unclonable function (PUF) core" as hardware-based security feature (KIT) ٠
- protection against manipulation in form of fluorecent particle patterns in the pipe material

electronic system" aiming at a secure identification ental 5 © Continenta © Polysecure





Knowledge Transfer / Networking

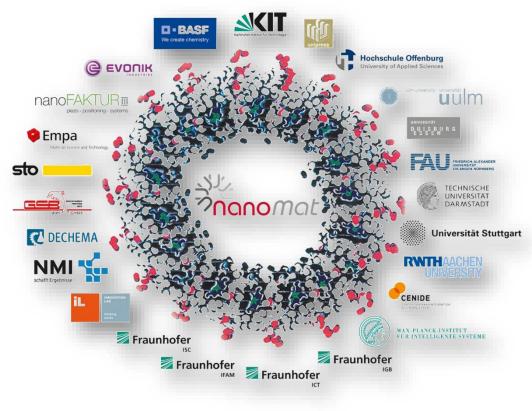


Networking between Industry and Academia NanoMat within the Center MaTeLiS

Industry

BASF SE GSB-Wahl GmbH nanoFAKTUR GmbH Continental Polysecure Cyient Beyond 2D Ingun GmbH MEMIS Infineon

Associations DECHEMA IHK und TRK Karlsruhe



Universities

University Duisburg-Essen Karlsruhe Institute of Technology University Ulm University Warsaw University Konstanz HS Offenburg University Stuttgart University Heidelberg

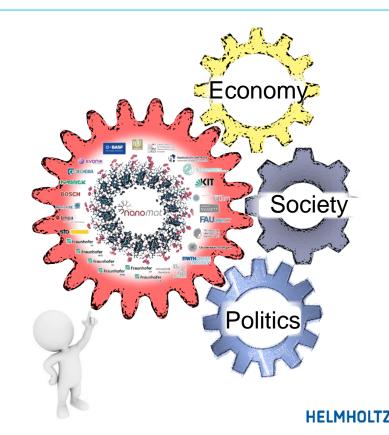
Research Institutes

EMPA (Zürich) Fraunhofer IFAM Fraunhofer ISC MPI-IS, Stuttgart NMI Tübingen

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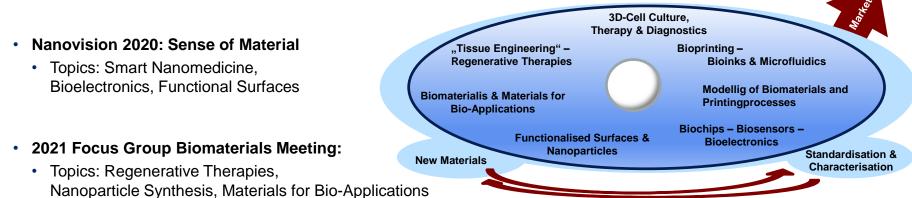
Networking between Industry and Academia The Center's Mission

- knowledge transfer between industry and science
- initiate new cooperations
- generate visibility for nanomaterials in politics, international bodies and the public



Networking between Industry and Academia Focus Group Biomaterials

- Mission: Cooperation Industry/Academia, Projects for Innovation and Commercialization
- Regular meetings of members (Speakermeetings + Events)
- 30 Members



• 2022 Materials Day (MaTeLis – NanoMat):

Topics: Virtual Material Design, Biomimetic Materials, Bioprinting

Upcoming Event MaTeLiS Science-Industry-Symposium



KIT - The Research University in the Helmholtz Association

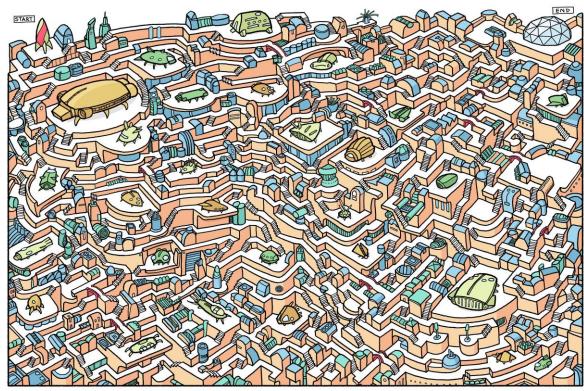
www.kit.edu





https://www.nanomat.de/Nanomat-Symposium-2022.php

Conclusions Choose your Path – there are many!



Lessons learned (for me):

- take part in the relevant networks
- seek early contact to the research and innovantion management at your institution
- make use of different support offers
- choose the path that fits **you** best

THANKS FOR YOUR ATTENTION!

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